

Monolithic Dual N Channel JFET

Rev. V1

Features

- Available in JAN, JANTX and JANTXV per MIL-PRF-19500/430
- Monolithic Design
- Low Offset/Drift Voltage
- Low Noise, Low Gate Leakage
- Ideal for Hi-Rel High Speed, Temp-Compensated, Single-Ended Input Amps
- High-Speed Comparators
- TO-71 package



Electrical Characteristics (T_A = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Units	Min.	Max.
Reverse Gate Current	$V_{GS} = -50 \text{ V dc}; V_{DS} = 0$	I _{GSS1}	μA dc		-1.0
Reverse Gate Current	$V_{GS} = -30 \text{ V dc}; V_{DS} = 0$	I _{GSS2}	nA dc	_	-0.1
Drain Current	$V_{DS} = 15 \text{ V dc}; V_{GS} = 0$	I _{DSS}	mA dc	0.5	8.0
Gate Current	V_{DG} = 15 V dc; I_{D} = 200 μA dc	I _G	pA dc	ĺ	-50
Gate Source Cutoff Voltage	V_{DS} = 15 V dc; I_{D} = 0.5 nA dc	$V_{GS(off)}$	V dc	-0.5	-4.5
Gate-Source Voltage Differential	V_{DG} = 15 V dc; I_{D} = 50 μ A dc 2N5545 2N5546 2N5547	IV _{GS1} -V _{GS2} I ¹	mV dc	_	5 10 15
Gate-Source Voltage Differential	V_{DG} = 15 V dc; I_{D} = 200 μ A dc; 2N5545 2N5546 2N5547	IV _{GS1} -V _{GS2} I ²	mV dc	_	5 10 15
Gate-Source Voltage Differential Change With Temperature	V_{DG} = 15 V dc; I_{D} = 200 μ A dc; $T_{A(1)}$ = +25°C; $T_{A(2)}$ = -55°C 2N5545 2N5546 2N5547	$I\Delta V_{GS1}$ - V_{GS2} $_{\Delta}T_{A}I$		_	.8 1.6 3.2

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Electrical Characteristics (T_A = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Units	Min.	Max.
Gate-Source Voltage Differential Change With Temperature	V_{DG} = 15 V dc; I_{D} = 200 μ A dc; $T_{A(1)}$ = +25°C; $T_{A(2)}$ = +125°C 2N5545 2N5546 2N5547	$I\Delta V_{GS1}\text{-}V_{GS2)\Delta}T_{A}I$	mV dc	_	1 2 4
Zero-Gate-Voltage Drain Current Ratio	V_{DS} = 15 V dc; V_{GS} = 0; 2N5545 2N5546 2N5547	I _{DSS1}		0.95 0.90 0.90	1.05 1.10 1.10
Small-Signal Common-Source Short-Circuit Forward Transfer Admittance Ratio	V_{DG} = 15 V dc; I_{D} = 200 μA dc; f = 1 kHz	$\frac{ y_{fs} ^1}{ y_{fs} ^2}$		0.97 0.95 0.90	1.03 1.05 1.10
Small-Signal Common-Source Short-Circuit Output Admittance Differential	V_{DS} = 15 V dc; V_{GS} = 0; f = 1 kHz 2N5545 2N5546 2N5547	lly _{os} l ¹ -ly _{os} l ^{l2l}	μmho		1 2 3

Electrical Characteristics (T_A = 150°C unless otherwise noted)

Parameter	Test Conditions	Symbol	Units	Min.	Max.
Reverse Gate Current	$V_{GS} = -30 \text{ V dc}; V_{DS} = 0$	I _{GSS3}	nA dc	_	-150
Gate Current Differential	V_{DG} = 15 V dc; I_{D} = 200 uA dc; T_{A} = +125°C	_{G1} - _{G2}	nA dc	_	5



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Electrical Characteristics

Parameter	Test Conditions	Symbol	Units	Min.	Max.
Dynamic Characteristics					
Spot Noise Figure (2N5545, 2N5546 only)	V_{DS} = 15 V dc; I_D = 200 μA dc; f = 10 Hz; R_G = 1 MΩ; Noise Bandwidth = 5 Hz 2N5545 2N5546	NF	dB	_	3.5 5.0
Small-Signal, Common-Source Short-Circuit Forward Transfer Admittance	V _{DS} = 15 V dc; V _{GS} = 0; f = 100kHz ≤ f≤1 MHz	ly _{fs} l	mmho	1.5	6.0
Small-Signal, Common-Source Short-Circuit Reverse Transfer Capacitance	V _{DS} = 15 V dc; V _{GS} = 0 V dc; f = 100kHz <u><</u> f <u><</u> 1 MHz	C _{rss}	pF	_	2
Small-Signal, Common-Source Short-Circuit Input Capacitance	V _{DS} = 15 V dc; V _{GS} = 0 V dc; f = 100kHz <u><</u> f <u><</u> 1 MHz	C _{iss}	pF	_	6
Small-Signal, Common-Source Short-Circuit Output Admittance	V _{DS} = 15 V dc; V _{GS} = 0 V; f = 100kHz <u>< f<</u> 1 MHz	ly _{os} l	μmho	_	25
Equivalent Input Noise Voltage	V _{DS} = 15 V dc; I _D = 200 µA dc: Noise bandwidth = 5 Hz 2N5545 2N5546	Vn	nV√Hz		180 200
Magnitude of Small-Signal, Common-Source, Short-Circuit Forward Transfer Admittance	V_{DS} = 15 V dc; V_{GS} = 0; F = 1 kHz T_A = -65°C	ly _{fs} l	mmho		10.0



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Absolute Maximum Ratings (25°C unless otherwise specified)

Ratings	Symbol	Value
Voltage Drain-Gate Breakdown	V_{DG}	50 V dc
Voltage Gate-Source Breakdown	V _{GS}	-50 V dc
Gate Current	I _G	30 mA dc
Maximum Power Dissipation @ T _A = +25°C One section Both sections	P _T ⁽¹⁾	250 mW 400 mW
Storage Temperature Range	T _{STG}	-65°C to +200°C

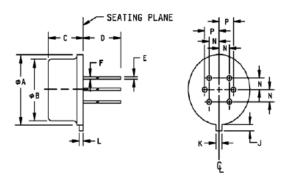
⁽¹⁾ Derate linearly 1.6 mW/ $^{\circ}$ C for T_A > +25 $^{\circ}$ C one section, 2.67 mW/ $^{\circ}$ C both sections

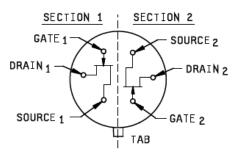


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Outline Drawing TO-71





CONNECTION DIAGRAM

Ltr	Inc	hes	Millimeters		Notes
	Min	Max	Min	Max	
φА	.209	.230	5.31	5.84	
φВ	.178	.195	4.52	4.95	
С	.170	.210	4.32	5.33	
D	.500	.750	12.70	19.05	
Е		.021		0.53	3
F	.016	.019	0.41	0.48	4
J	.028	.048	0.71	1.22	7
К	.036	.046	0.91	1.17	
L		.020		0.51	
N	.0146	Nom.	.037 Nom.		5
Р	.0354	Nom.	.90 Nom.		5

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Measured in the zone beyond .250 inch (6.35 mm) from the seating plane.
- 4. Measured in the zone from .50 inch (1.27 mm) to .250 inch (6.35 mm) from the seating plane.
- 5. When measured in a gauging plane .054 +.001, -.000 inch (1.37 -0.03, -0.00 mm) below the seating plane of the transistor, maximum diameter leads shall be within .007 inch (0.18 mm) of their true location relative to a maximum width tab. Smaller diameter leads shall fall within the outline of the maximum diameter lead tolerance.
- 6. All leads electrically insulated from case and each section electrically isolated from the other.
- 7. Measured from the maximum diameter of the actual device.

FIGURE 1. Physical dimensions (similar to TO-71).



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